



Product Change Notification

Change Notification #: 118599-00
Change Title: Intel® Storage Adapter RSP3QD160J,
PCN 118599-00, Product Design,
Firmware update
Date of Publication: October 15, 2021

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material *	October 30, 2021
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

The Intel SKU listed in the products affected table will have the following change.

- Update the firmware to Phase 10 (firmware package 10.00.01.02)

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Intel® Storage Adapter RSP3QD160J, 5 Pack	RSP3QD160J	954491	J40727-003	J40735-202	J40727-004	J40735-203

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
October 15, 2021	00	Originally Published PCN



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118599-00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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